N Channel MOSFET

multicomp PRO

RoHS Compliant



Features

- VDS (V) = 100V
- ID =-6.6A (VGS =±20V)
- $R_{DS(ON)} < 28m\Omega (V_{GS} = 10V)$
- Rds(on) < 38mΩ (Vgs =4.5V)

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit	
Drain-Source Voltage		Vds	100	v	
Gate-Source Voltage		Vgs	±20		
Continuous Drain Current			6.6		
Pulsed Drain Current	d Drain Current		40	A	
Power Dissipation ^{1a}	TA=25°C		2.2	14/	
Power Dissipation ^{1b}	TA=25°C	- P□	1	W	
Single Pulse Avalanche Energy ³		Eas	84	mJ	
Thermal Resistance.Junction- to-Ambient ^{1a}		RthJA	55	°C/W	
Thermal Resistance.Junction- to-Case ¹		RthJC	12		
Junction Temperature	TJ	150	°C		
Storage Temperature Range	Tstg	-55 to +150			

Electrical Characteristics Ta = 25°C

Characteristic	Symbol	Conditions	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	Vdss	ID=-250µA, VGs=0V	100			V
Zero Gate Voltage Drain Current	IDSS	VDS=80V, VGS=0V			-1	uA
Gate-Body leakage current	lgss	VDS=0V, VGS=±20V			±100	nA
Gate Threshold Voltage	VGS(th)	Vds=Vgs Id=250µA	1		3	V
Static Drain-Source On-Resistance		Vgs=10V, Id=6.6A			28	
	RDS(On)	Vgs=4.5V, Id=5.5A			38	mΩ
		Vgs=10V, Id=6.6A TJ=125°C			46	1
Forward Transconductance	g FS	VDS=5V, ID=6.6A		26		S
Input Capacitance	Ciss				1490	
Output Capacitance	Coss	Vgs=0V, Vds=50V, f=1MHz			245	pF
Reverse Transfer Capacitance	Crss				15	



Characteristic	Symbol	Conditions		Min	Тур	Max	Unit
Gate Resistance	Rg				0.5		Ω
Total Gate Charge	Qg(TOT)	Vgs=0V to 10V				25	
		Vgs=0V to 4.5V				12	nC
Gate Source Charge	Qgs				2.6		
Gate Drain Charge	Qgd	Vds=50V, Id=6.6A			2.2		
Turn-On DelayTime	td(on)	Vgs=10V, Vds=50V, Id=6.6A, Rgen=6Ω				14	nS
Turn-On Rise Time	tr					10	
Turn-Off DelayTime	td(off)					31	
Turn-Off Fall Time	tr					10	
Body Diode Reverse Recovery Time	trr	l⊧= 6.6A, dl/dt= 100A/µs				64	
Body Diode Reverse Recovery Charge	Qrr					58	
Maximum Body-Diode Continuous Current	ls					6.6	A
Diode Forward Voltage ²	Vsd	Is=6.6A,Vgs=0V				1.3	V
	VSD	Is=1A,Vgs=0V				1.2	

NOTES:

1. R θ JA is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 × 1.5 in. board of FR-4 material. R θ JC is guaranteed by design while R θ CA is determined by the user's board design.

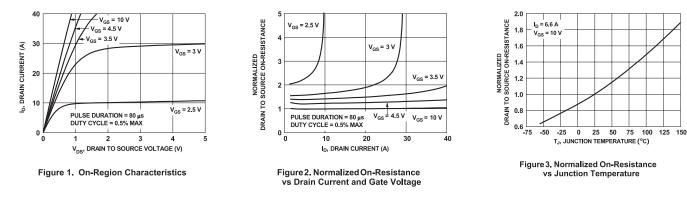
a: 55°C/W when mounted on a 1 in² pad of 2 oz copper

b: 118°C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0 %.

3. Starting $T_J = 25^{\circ}C$, L = 1mH, $I_{AS} = 13A$, $V_{DD} = 90V$, $V_{GS} = 10V$.

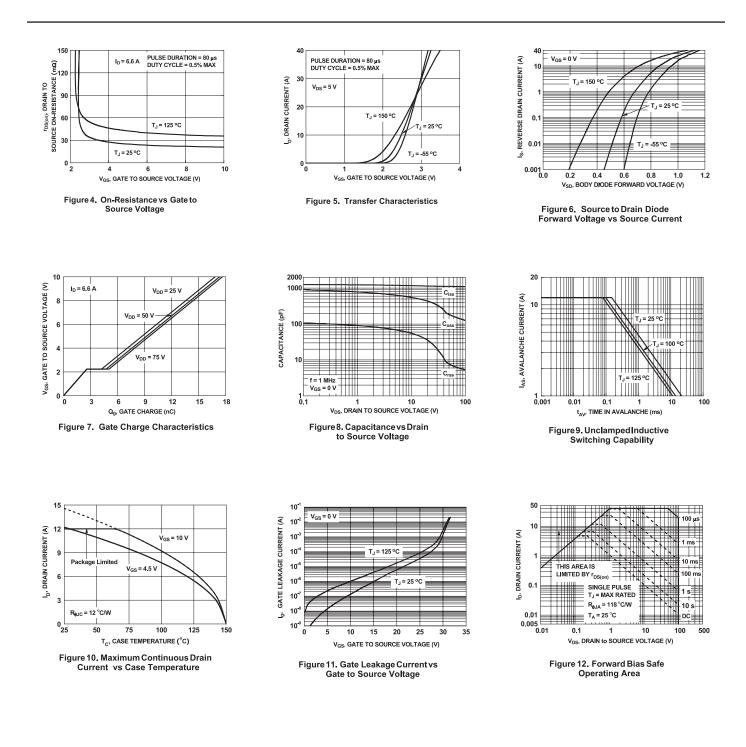
Typical Characterisitics





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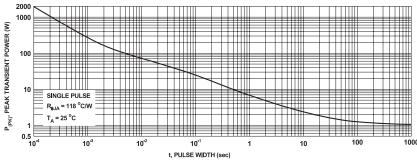


Figure 13. Single Pulse Maximum Power Dissipation

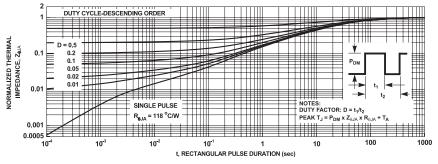
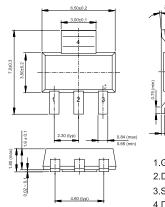


Figure 14. Junction-to-Ambient Transient Thermal Response Curve

Diagram



1.Gate 2.Drain 3.Source 4.Drain

Part Number Table

Description	Part Number		
N Channel MOSFET, 6.6A, 100V	FDT86102LZ		

Dimensions : Millimetres

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